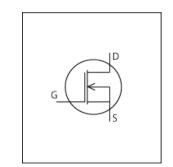


# PSpice Model NMOS ON NVMFSC0D9N04C



## **Model Information**

Model A macro model based on BSIM3 model

Call Name MDC\_NVMFSC0D9N04C\_PS Pin Assign 1:S 2:S 3:S 4:G 5:D 6:D 7:D 8:D

File List Model Library MDC\_NVMFSC0D9N04C\_PS01.lib

Model Report MDC\_NVMFSC0D9N04C\_PS.pdf (this file)

**Verified Simulator Version** 

Note

PSpice version 16.6

#### References

The information which was used for modeling is as follow:

[Data Sheet]

Date/Version
Product name
Company name
February,2020 - Rev.1
NVMFSC0D9N04C
ON Semiconductor.

● Characteristics IdVds[Vgs],IdVgs[Temp],Rds(on)Vgs[Id],Rds(on)Id[Vgs],

Rds(on)Temp[Vgs],Crss,Coss,Ciss,VgsQg[Vdd],

IsVsd[Temp],tdon,tdoff,tf,tr

#### Simulation Range

This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

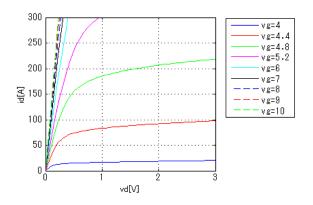
Item	Range			Unit
	Min.		Max.	
Drain-source voltage (DC)	0	to	40	V
Gate-source voltage (DC)	0	to	20	V
Temperature	-55	to	175	deg C



Simulation results are following. Explanatory notes — : simulated

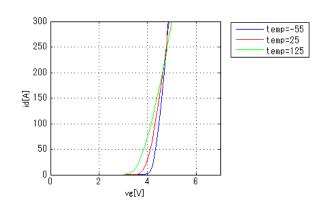
## IdVds[Vgs]

Temp. = 25deg C

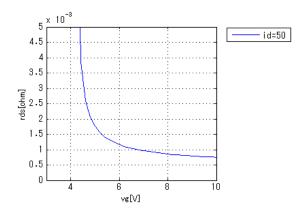


## IdVgs[Temp]

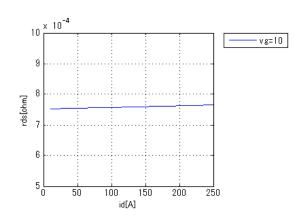
Vds = 10V



## Rds(on)Vgs[Id]

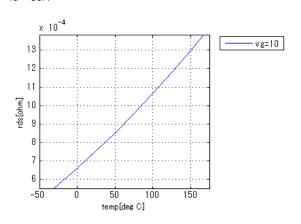


## Rds(on)Id[Vgs]



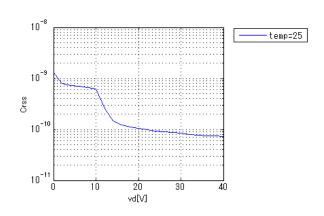
## Rds(on)Temp[Vgs]

Id = 50A



### **Crss**

Freq. = 1MHz

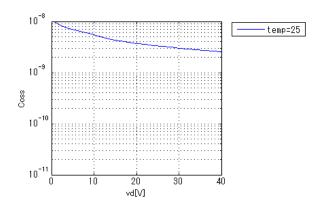




Simulation results are following. Explanatory notes — : simulated

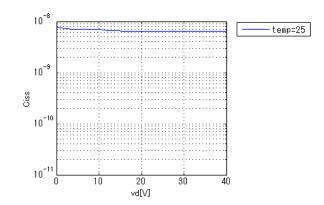
#### Coss

Freq. = 1MHz



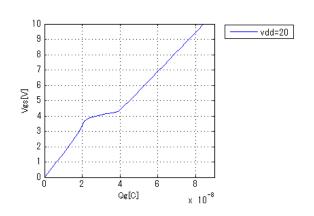
### Ciss

Freq. = 1MHz

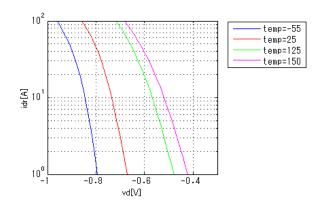


## VgsQg[Vdd]

Id = 50A

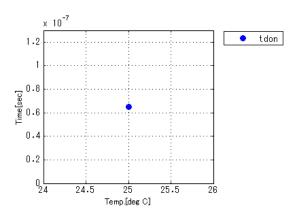


## IsVsd[Temp]



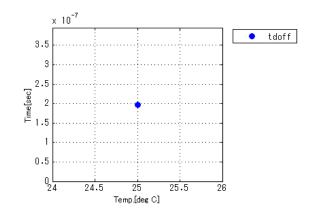
### tdon

Vdd = 32V, Id = 50A, +Vg = 10V, -Vg = 0V, Rg = 2.5ohm



### tdoff

Vdd = 32V, Id = 50A, +Vg = 10V, -Vg = 0V, Rg = 2.50hm

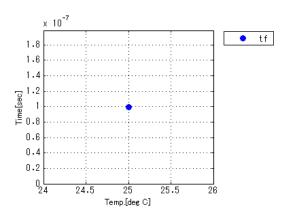




## Simulation results are following. Explanatory notes — : simulated

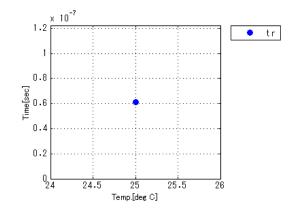
#### tf

Vdd = 32V, Id = 50A, +Vg = 10V, -Vg = 0V, Rg = 2.5ohm



#### tr

Vdd = 32V, Id = 50A, +Vg = 10V, -Vg = 0V, Rg = 2.5ohm





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MoDeCH Inc.

**Head Office** 

Location: Taiju-Seimei-Hachioji Bldg., 5-15 Yokoyama-cho, Hachioji-Shi, Tokyo 192-0081, Japan

Tel:+81-42-656-3360

E-Mail:model-on-support@modech.co.jp

URL:http://www.modech.com/en/

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